ASSOCIATION CONNECTING ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	IPC. Bannockł	ourn, Illinois, A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the su	bstances v s all lower	vithin the manufactu level materials for v	urer listed which the	item. Note: nanufacture	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				rials and N	als and Mfg Information				
upplier Information														
Company name* Con			Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2023-0	2023-06-08			
Contact Name Title - Contact			act			Phone - Contact*				Email ·	Email - Contact*			
Product-Env-Stewards Product En			et Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repr			Representative			Phone - Representative*				Email ·	Email - Representative*			
Product-Env-Stewards Product Envir			viro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Imber Mfr Item Name			Effective Date Version Manufac		lanufacturing Site	Weight*		UOM	Unit Type		
	CAT251	CAT25128XI-T2 128KB SPI 3		SER CMOS EEPROM		2023-06-08		T	TH6		135.21	mg	Each	
Ianufacturing Proccess Informa	ation						-	·						
Terminal Plating / Grid Array M	laterial 7	rial Terminal Base Allo		J-STD-020 MSL Rating		Peak Proc	Peak Process Body Temperatu		ure Max Time at Peak Temper		ture Num	ber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		3		260		С	30	seco	nds 3			
omments														
<b>TTENTION: MSL 3 Rated item requir</b>	es Bake and D	ry Pack (after	electrical test)											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl ohthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.12	mg	Supplier	Silicon (Si)	7440-21-3		3.12	mg
Die Attach	0.42	mg	Supplier	Silver (Ag)	7440-22-4		0.315	mg
			Supplier	Epoxy resins	129915-35-1		0.105	mg
Lead Frame 4	44.7	mg	Supplier	Silver (Ag)	7440-22-4		0.3576	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0536	mg
			Supplier	Iron (Fe)	7439-89-6		1.0504	mg
			Supplier	Copper (Cu)	7440-50-8		43.2249	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0134	mg
Mold Compound-Black	85.59	mg		Epoxy Phenol Resin	proprietary data		8.9869	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		76.603	mg
Plating	1.21	mg	Supplier	Tin (Sn)	7440-31-5		1.21	mg
Wire Bond - Au	0.17	mg	Supplier	Gold (Au)	7440-57-5		0.17	mg